

DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION

EL465782276US

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled "Method of Forming Integrated Circuitry, Method of Forming a Contact Opening, and Integrated Circuitry", the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

PRIOR FOREIGN APPLICATIONS:

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States

Code and that such willful false statement may jeopardize the validity of the application or any patent issued therefrom.

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Full name of inventor: **SHANE J. TRAPP**

Inventor's Signature: Shane J. Trapp

Date: 7/25/01

Residence: **Boise, Idaho**

Citizenship: **U.S.A.**

Post Office Address: **1760 East Victory Road
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Full name of inventor: **BRIAN F. LAWLOR**

Inventor's Signature: Brian F. Lawlor

Date: 7/27/01

Residence: **Boise, Idaho**

Citizenship: **U.S.A.**

Post Office Address: **6183 South Schooner Place
Boise, ID 83706**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. Unknown
Filing Date Filed Herewith
Inventor Shane J. Trapp et al.
Assignee Micron Technology, Inc.
Group Art Unit Unknown
Examiner Unknown
Attorney's Docket No. MI22-1673
Title: Method of Forming Integrated Circuitry, Method of Forming a Contact
Opening, and Integrated Circuitry

POWER OF ATTORNEY BY ASSIGNEE AND
CERTIFICATE BY ASSIGNEE UNDER 37 CFR § 3.73(b)

To: Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

MICRON TECHNOLOGY, INC., the Assignee of the entire right, title and
interest in the above-identified patent application by assignment attached
hereto, hereby appoints the attorneys and agents of the firm of WELLS, ST.
JOHN, ROBERTS, GREGORY & MATKIN P.S., listed as follows:

David P. Roberts	Reg. No. 23,032
Randy A. Gregory	Reg. No. 30,386
Mark S. Matkin	Reg. No. 32,268
James L. Price	Reg. No. 27,376
Deepak Malhotra	Reg. No. 33,560
Mark W. Hendrickson	Reg. No. 32,356
David G. Latwesen	Reg. No. 38,533
George G. Grigel	Reg. No. 31,166
Keith D. Grzelak	Reg. No. 37,144
James D. Shaurette	Reg. No. 39,833
Frederick M. Fliegel	Reg. No. 36,138
Donald Brent Kenady	Reg. No. 40,045
James E. Lake	Reg. No. 44,854
Bernard Berman	Reg. No. 37,279
Jennifer J. Taylor, Ph.D.	Reg. No. P 48,711

and also attorneys Michael L. Lynch (Reg. No. 30,871) and Charles B. Brantley II (Reg. No. 38,086) of Micron Technology, Inc., as its attorneys with full power of substitution to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

The Assignee certifies that the above-identified Assignment has been reviewed and to the best of Assignee's knowledge and belief, title is in the Assignee, and a copy of the Assignment is submitted herewith.

Please direct all correspondence regarding this application to:

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MICRON TECHNOLOGY, INC.

Dated: 8-2-05 By: Michael L. Lynch
Name: Michael L. Lynch, Esq.
Title: Chief Patent Counsel

Attachment: Copy of Assignment; Copy of Board of Directors' Resolution